Si2369BDS

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PRODUCT SUMMARY

 $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V

 $R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V

V_{DS} (V)

Q_g typ. (nC)

Configuration

I_D (A) a, e

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-30

0.0270

0.0390

6.2

-7.5

Single

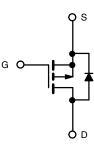
FEATURES

P-Channel 30 V (D-S) MOSFET

- TrenchFET[®] Gen IV p-channel power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Load switch
- Circuit protection
- Motor drive control



RoHS

COMPLIANT

HALOGEN

FREE

P-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	Si2369BDS-T1-GE3

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, u	Inless otherv	vise noted)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-30 -20 / +16	V
Gate-source voltage		V _{GS}		V
	T _C = 25 °C		-7.5 ^e	
Operation of the intervent (T 150 °C)	T _C = 70 °C	1. [-6.3	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-5.6 ^{b, c}	
	T _A = 70 °C		-4.4 ^{b, c}	А
Pulsed drain current (t = 100 µs)		I _{DM}	-50	
Continuous source-drain diode current	T _C = 25 °C	I _S	-2.1	
	T _A = 25 °C		-1.1 ^{b, c}	
	T _C = 25 °C		2.5	
Maximum power dissipation	T _C = 70 °C		1.6	14/
	T _A = 25 °C	PD	1.3 ^{b, c}	W
	T _A = 70 °C	1	0.8 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient ^b	t ≤ 5 s	R _{thJA}	75	100	°C/W		
Maximum junction-to-case (drain)	Steady state	R _{thJF}	40	50	C/W		

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 166 °C/W

e. Package limited

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			1		1	•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = -250 μA	-	15.4	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	-5.1	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	-1	-	-2.2	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = -20 V / +16 V$	-	-	100	nA	
Zaus ante colta da ducia comont		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	-15		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10$ V, $V_{GS} = -10$ V	-10	-	-	A	
D · · · · · · · ·		V _{GS} = -10 V, I _D = -5 A	-	0.0225	0.0270	- Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$	-	0.0325	0.0390		
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -5 A	-	10	-	S	
Dynamic ^b				•		•	
Input capacitance	C _{iss}		-	745	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	340	-		
Reverse transfer capacitance	C _{rss}		-	40	-		
Total gate charge	Q _g –	V_{DS} = -15 V, V_{GS} = -10 V, I_D = -5.6 A	-	12.9	19.5	nC	
			-	6.2	9.3		
Gate-source charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_{D} =-5.6 A	-	2.7	-		
Gate-drain charge	Q _{gd}		-	2	-		
Gate resistance	R _g	f = 1 MHz	3.1	18.3	31	Ω	
Turn-on delay time	t _{d(on)}		-	12	24		
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 3.4 \Omega, \text{ I}_{D} \cong -4.4 \text{ A},$	-	6	12	1	
Turn-off delay time	t _{d(off)}	V_{GEN} = -10 V, R_g = 1 Ω	-	40	80		
Fall time	t _f		-	22	44	1	
Turn-on delay time	t _{d(on)}		-	25	50	- ns - -	
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 3.4 \Omega, \text{ I}_{\text{D}} \cong -4.4 \text{ A},$	-	55	110		
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	40	80		
Fall time	t _f		-	25	50		
Drain-Source Body Diode Characteristi	cs			•		I	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-2.1		
Pulse diode forward current	I _{SM}		-	-	-50	A	
Body diode voltage	V _{SD}	I _S = -4.4 A, V _{GS} = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	19	38	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -4.4 A, di/dt = 100 A/μs,	-	8	16	nC	
Reverse recovery fall time	t _a	$T_J = 25 \text{ °C}$	-	9	-		
Reverse recovery rise time	t _b		-	10	-	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

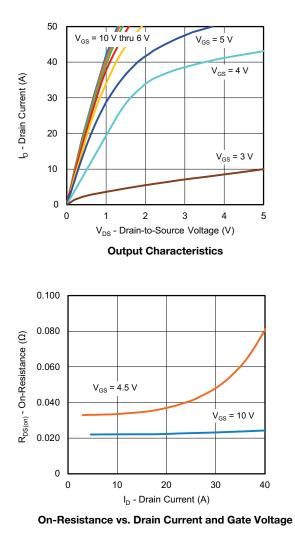
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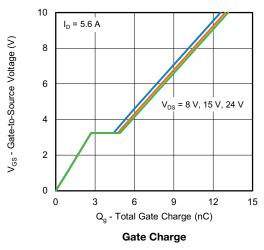


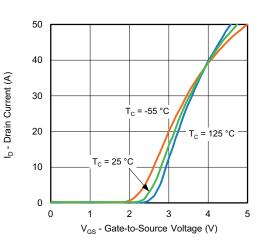
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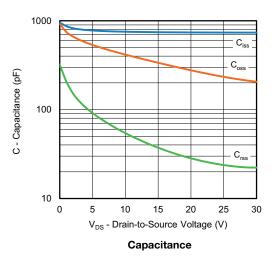
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

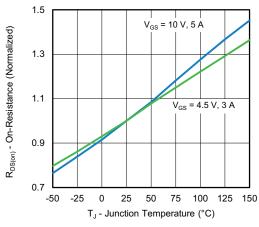






Transfer Characteristics





On-Resistance vs. Junction Temperature

S19-0397-Rev. A, 06-May-2019

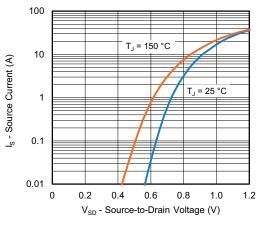
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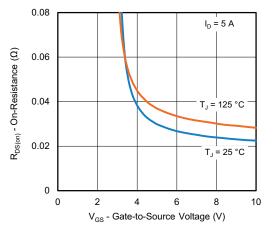


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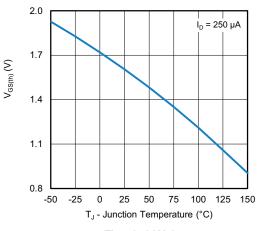
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



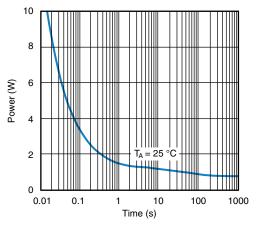
Source-Drain Diode Forward Voltage



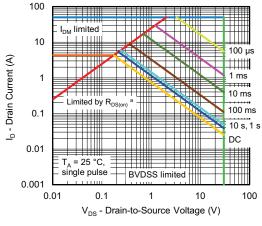
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

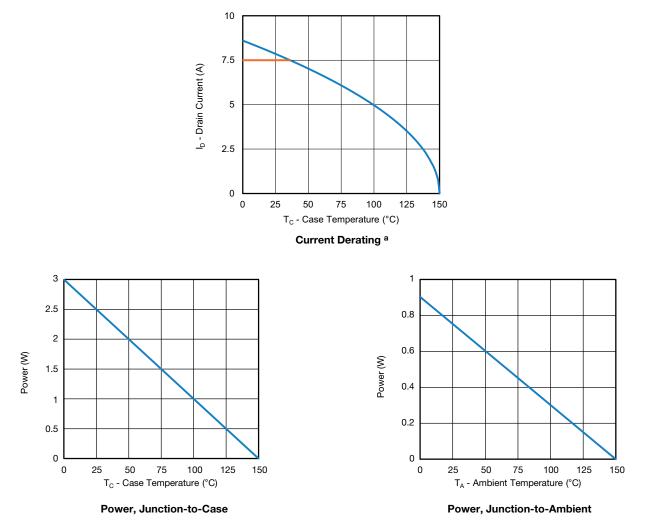
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

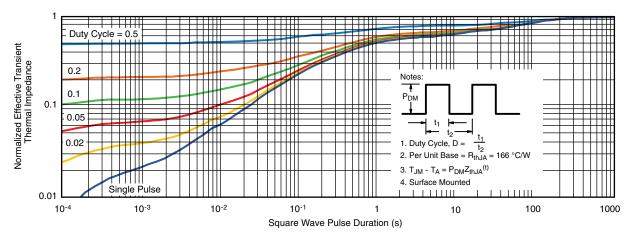
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



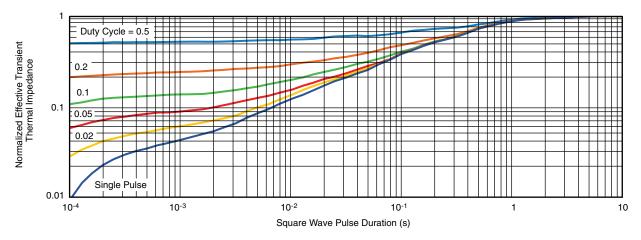
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77098.



Package Information

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SOT-23 (TO-236): 3-LEAD





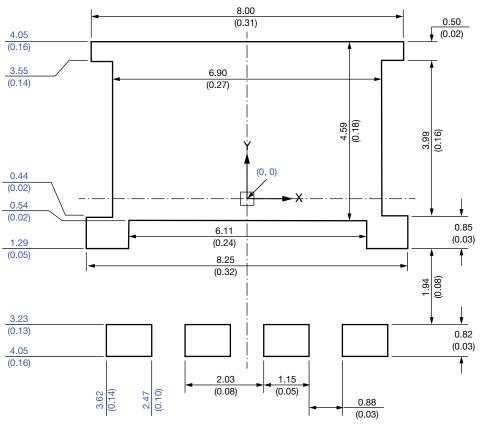


Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



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Recommended Minimum PADs for PowerPAK® 8 x 8L Single



Dimensions in millimeters (inches)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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